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# 4AK25

Silicon N-Channel Power MOS FET Array



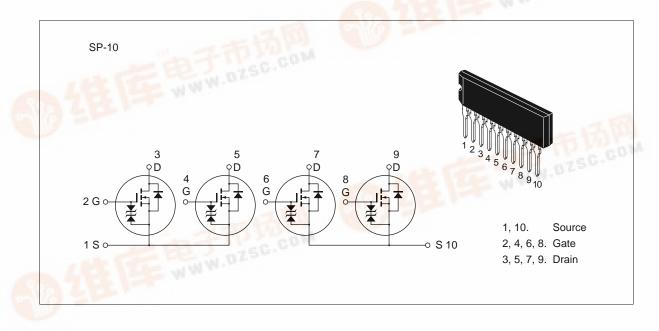
### Application

High speed power switching

#### Features

- Low on-resistance  $R_{DS(on)} = 0.45$ ,  $V_{GS} = 10$  V,  $I_D = 1$  A
- Low drive current
- High speed switching
- High density mounting

#### Outline





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## Absolute Maximum Ratings (Ta = $25^{\circ}$ C)

Symbol	Ratings	Unit	
V <sub>DSS</sub>	60	V	
V <sub>GSS</sub>	±20	V	
I <sub>D</sub>	1.5	А	
↓ → 1 D(pulse)	4.5	А	
I <sub>DR</sub>	1.5	А	
Pch (Tc = 25°C)*2	24	W	
Pch*2	3.6	W	
Tch	150	°C	
Tstg	–55 to +150	°C	
	$V_{DSS}$ $V_{GSS}$ $I_D$ $I_{D(pulse)}^{*1}$ $I_{DR}$ Pch (Tc = 25°C)^{*2} Pch <sup>*2</sup> Tch	V       60 $V_{GSS}$ ±20 $I_D$ 1.5 $I_{D(pulse)}^{*1}$ 4.5 $I_{DR}$ 1.5         Pch (Tc = 25°C)*2       24         Pch*2       3.6         Tch       150	

Notes: 1.  $PW \le 10 \ \mu s$ , duty cycle  $\le 1\%$ 

2. 4 Devices operation

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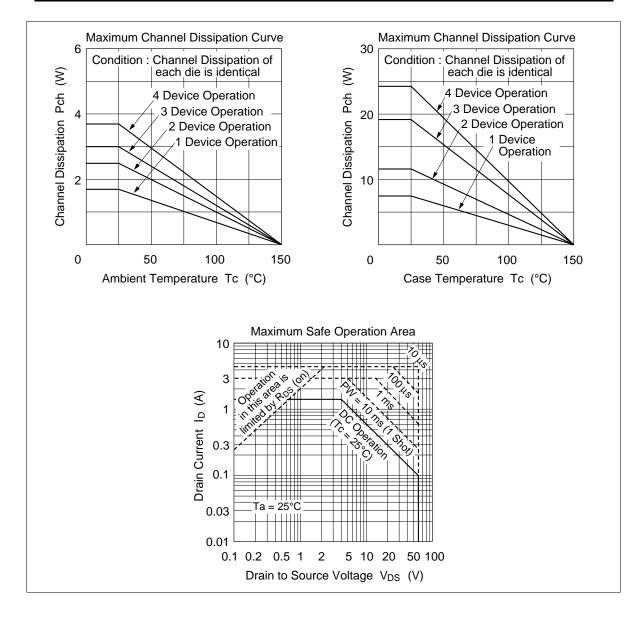
# **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{\rm (BR)DSS}$	60	_	_	V	$I_{\rm D} = 10$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{\rm (BR)GSS}$	±20	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μΑ	$V_{gs} = \pm 16 \text{ V}, \text{ V}_{ds} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	250	μΑ	$V_{\rm DS} = 50 \ V, \ V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.0	V	$I_{\rm D}$ = 1 mA, $V_{\rm DS}$ = 10 V
Static drain to source on state resistance	$R_{DS(on)}$	_	0.35	0.45	Ω	$I_{D} = 1 A$ $V_{GS} = 10 V^{*1}$
		_	0.47	0.65	Ω	$I_{D} = 1 A$ $V_{GS} = 4 V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	0.9	1.5	_	S	$I_{\rm D} = 1 \text{ A}$ $V_{\rm DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	—	140	—	pF	V <sub>DS</sub> = 10 V
Output capacitance	Coss	_	70	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	20	_	pF	f = 1 MHz
Turn-on delay time	t <sub>d(on)</sub>	—	3	_	ns	I <sub>D</sub> = 1 A
Rise time	t,	_	12	—	ns	V <sub>GS</sub> = 10 V
Turn-off delay time	$t_{d(off)}$	_	50	_	ns	$R_{L} = 30 \Omega$
Fall time	t <sub>f</sub>	_	30	—	ns	
Body to drain diode forward voltage	$V_{DF}$	_	1.1	_	V	$I_{\rm F} = 1.5$ A, $V_{\rm GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	—	70	—	μs	$I_{F} = 1.5 \text{ A}, V_{GS} = 0,$ dIF/dt = 50 A/ $\mu$ s

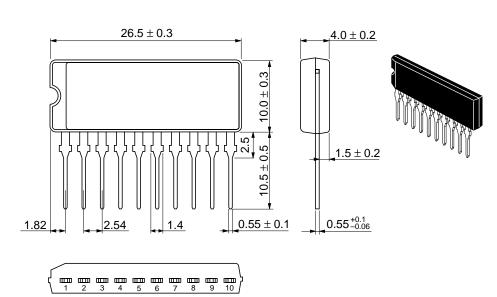
Note: 1. Pulse Test

See characteristic curves of 2SK975

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Unit: mm

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